

V23818-M305-L57^(*) Small Form Factor Multimode 850 nm 2.125 and 1.0625 GBd Fibre Channel 2x5 Transceiver with LC[™] Connector

7 11 3.56 9x 1.78 [.07] = 16 [.63] [.14] Dimensions in mm [inches] Circuit Board Layout (6x) (6x) (6x) [.28] Recommended PCB thickness max. 2.54 [0.1] 1.78 [.07] 6x \$\$[.055 ±.04] 13.34 10.16 4.57 [.18] 0.81 ±0.1 20x Φ[.032 ±.04] (20x) - ⊕ Ø 0.05 @ 28.45 [1.12] 12.71 [.5] 10.16 [.4] 13.43 [.529] 12.87 [.507] 9.61 [.379] 0.25 [.01] (5x 0.38 x 0.254 [.015 x .01]) 0.38 [.015] 3.57 [.14] Š 3 [.117] ο 0 9x) 1.45 [.057] <u>6</u> 0 0 0 17.78 [.7] 4.5<mark>6</mark> 0 47.65 [1.876] a 0 0 ₽₿ ñ 3.1 [.122] 4.75 [581] Ц 18.59 [.732] 9.11 [.359] 12.75 [.502] 10.7 [.42] 14.8 [.583] a) recommended bezel position



*) Ordering Information

| Input | Output | Signal detect | Voltage | Part number |
|-------|--------|---------------|---------|-----------------|
| AC | AC | TTL | 3.3 V | V23818-M305-L57 |

FEATURES

- Small Form Factor transceiver
- Full compliant with Fibre Channel
- Data rate autonegotiation between 1.0625 and 2.125 GBd
- Excellent EMI performance
- RJ-45 style LC[™] connector system
- Half the size of SC Duplex 1x9 transceiver
- Single power supply (3.3 V)
- · Extremely low power consumption of 445 mW typical
- PECL and LVPECL differential inputs and outputs
- + System optimized for 62.5/50 μm graded index fiber
- Multisource 2x5 footprint
- Small size for high port density
- UL-94 V-0 certified
- ESD Class 1 per MIL-STD 883D Method 3015.7
- Compliant with FCC (Class B) and EN 55022
- · For distances of up to 300 m
- · Class 1 FDA and IEC laser safety compliant
- AC/AC coupling in accordance to SFF MSA

Absolute Maximum Ratings

Exceeding any one of these values may destroy the device immediately.

| Package Power Dissipation | 1.5 W |
|---------------------------------|------------------------|
| Data Input Levels (PECL) | V _{CC} +0.5 V |
| Differential Data Input Voltage | |
| Operating Case Temperature | –10°C to 85°C |
| Storage Ambient Temperature | 40°C to 85°C |
| Soldering Conditions, Temp/Time | |
| (MIL-STD 883C, Method 2003) | 250°C/ 5.5 s |
| V _{CC} max | 5.5 V |
| ECL-Output current data | 50 mA |

DESCRIPTION

The Infineon Fibre Channel multimode transceiver – part of Infineon Small Form Factor transceiver family – is based on the Physical Medium Depend (PMD) sublayer and baseband medium, type (short wavelength), Fibre Channel DC 200-M5-SN-I and 200-M6-SN-I, DC 100-M5-SN-I and 100-M6-SN-I.

The appropriate fiber optic cable is 62.5 μm or 50 μm multimode fiber with LC^{\rm TM} connector.

Operating range over each optical fiber type at 2.125 GBd

| Fiber type | Minimum range (meters) | Тур. |
|-----------------|------------------------|------|
| 62.5 micron MMF | 0.5 to 150 | 300 |
| 50.0 micron MMF | 0.5 to 300 | 500 |

Operating range over each optical fiber type at 1.0625 GBd

| Fiber type | Minimum range (meters) | Тур. |
|-----------------|------------------------|------|
| 62.5 micron MMF | 0.5 to 300 | 400 |
| 50.0 micron MMF | 0.5 to 550 | 700 |

The Infineon Fibre Channel multimode transceiver is a single unit comprised of a transmitter, a receiver, and an LC^{M} receptacle. This design frees the customer from many alignment and PC board layout concerns.

This transceiver supports the LC[™] connectorization concept. It

is compatible with RJ-45 style backpanels for high end Data Com and Telecom applications while providing the advantages of fiber optic technology.

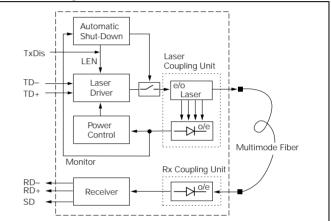
The module is designed for low cost SAN, LAN, WAN, Fibre Channel applications. It can be used as the network end device interface in mainframes, workstations, servers, and storage devices, and in a broad range of network devices such as bridges, routers, hubs, and local and wide area switches.

This transceiver operates at 1.0625 / 2.125 Gbit/s from a single power supply (+3.3 V). The full differential data inputs and outputs are PECL and LVPECL compatible.

Functional Description of 2x5 Pin Row Transceiver

This transceiver is designed to transmit serial data via multimode cable.

Functional Diagram



The receiver component converts the optical serial data into PECL compatible electrical data (RD and RDnot). The Signal Detect (SD, active high) shows whether an optical signal is present.

The transmitter converts PECL compatible electrical serial data (TD and TDnot) into optical serial data. Data lines are differentially 100 Ω terminated.

The transmitter contains a laser driver circuit that drives the modulation and bias current of the laser diode. The currents are controlled by a power control circuit to guarantee constant output power of the laser over temperature and aging.

The power control uses the output of the monitor PIN diode (mechanically built into the laser coupling unit) as a controlling signal, to prevent the laser power from exceeding the operating limits.

Single fault condition is ensured by means of an integrated automatic shutdown circuit that disables the laser when it detects laser fault to guarantee the laser Eye Safety.

The transceiver contains a supervisory circuit to control the power supply. This circuit makes an internal reset signal whenever the supply voltage drops below the reset threshold. It keeps the reset signal active for at least 140 milliseconds after the voltage has risen above the reset threshold. During this time the laser is inactive.

A low signal on TxDis enables transmitter. If TxDis is high or not connected the transmitter is disabled.

TECHNICAL DATA

The electro-optical characteristics described in the following tables are valid only for use under the recommended operating conditions.

Recommended Operating Conditions

| Parameter | Symbol | Min. | Тур. | Max. | Units | | |
|------------------------------------|--------------------------------------|------|------|------|-------|--|--|
| Case Temperature | T _c | -10 | | 85 | °C | | |
| Power Supply Voltage | V _{CC} - V _{EE} | 3.1 | 3.3 | 3.5 | V | | |
| Transmitter | Transmitter | | | | | | |
| Data Input Differential Voltage | V _{DIFF} | 250 | | 1600 | mV | | |
| Receiver | | | | | | | |
| Input Center Wavelength | λ_{C} | 770 | | 860 | nm | | |

Transmitter Electro-Optical Characteristics

| Transmitter | Symbol | Min. | Тур. | Max. | Units | |
|--|--|---------------|------|------|-------|-------|
| Launched Power (Average) ⁽¹⁾ | | | -10 | -6 | -4 | dBm |
| Optical Modula- tion Amplitude ⁽³⁾ | Optical Modula- tion Amplitude ⁽³⁾ 2.125 Gbit/s | | 196 | 450 | | μW |
| | 1.0625 Gbit/s | | 156 | 450 | | |
| Center Wavelength | 1 | λ_{C} | 830 | 850 | 860 | nm |
| Spectral Width (RM | 1S) | $\sigma_{ }$ | | | 0.85 | |
| Relative Intensity N | loise | RIN | | | -117 | dB/Hz |
| Extinction Ratio (D) | /namic) | ER | 9 | 13 | | dB |
| Reset Threshold ⁽²⁾ | V_{TH} | 2.5 | 2.75 | 2.99 | V | |
| Reset Time Out ⁽²⁾ | t _{RES} | 140 | 240 | 560 | ms | |
| Rise Time, 20%-80 | t _R | | 130 | 150 | ps | |
| Supply Current | | | | 45 | 65 | mA |

Notes

1. Into multimode fiber, 62.5 µm or 50 µm diameter.

- 2. Laser power is shut down if power supply is below ${\rm V}_{TH}$ and switched on if power supply is above ${\rm V}_{TH}$ after ${\rm t}_{RES}.$
- 3. Fibre Channel PI Standard.

Receiver Electro-Optical Characteristics

| Receiver | | Symbol | Min. | Тур. | Max. | Units |
|--|------------------|--|------|-------|------|-------|
| Sensitivity (Average | 2.125 Gbit/s | P _{IN} | | -18.5 | -16 | dBm |
| Power) ⁽¹⁾ | 1.0625 Gbit/s | | | -19 | -17 | |
| Saturation (Average Power) | | P _{SAT} | 0 | | | |
| Min. Optical Modulation | 2.125 Gbit/s | OMA | | 24 | 49 | μW |
| Amplitude ⁽⁶⁾ | 1.0625 Gbit/s | | | 19 | 31 | |
| Stressed Receiver er Sensitivity | 2.125 Gbit/s | S _{PIN} | | 29 | 96 | |
| 50 µm Fiber ⁽⁷⁾ | 1.0625 Gbit/s | | | 24 | 55 | |
| Stressed Receiv- er Sensitivity | 2.125 Gbit/s | S _{PIN} | | 34 | 109 | |
| 62.5 µm Fiber ⁽⁷⁾ | 1.0625 Gbit/s | | | 32 | 67 | |
| Signal Detect Assert Level ⁽²⁾ | • | P _{SDA} | | -21 | -18 | dBm |
| Signal Detect Deassert Level ⁽³⁾ | | P _{SDD} | -30 | -22 | | |
| Signal Detect Hysteresis | | P _{SDA} - P _{SDD} | 0.5 | 1 | | dB |
| Signal Detect Assert Time | | t _{ASS} | | | 100 | μs |
| Signal Detect Deassert Time | | t _{DAS} | | | 350 | |
| Receiver 3 dB cut-off Frequency ⁽⁶⁾ | | | | 1.3 | 1.5 | GHz |
| Receiver 10 dB cut-off Frequency ⁽⁶⁾ | | | | 1.6 | 3 | |
| Data Output Differential Voltage ⁽⁴⁾ | | V _{DIFF} | 0.5 | 0.7 | 1.23 | V |
| Return Loss of Receiver | A _{RL} | 12 | | | dB | |
| Supply current ⁽⁵⁾ | | | 80 | 90 | mA | |

Notes

 Average optical power at which the BER is 1 x 10E–12. Measured with a 2⁷–1 NRZ PRBS and ER=9 dB.

- 2. An increase in optical power above the specified level will cause the SIGNAL DETECT output to switch from a Low state to a High state.
- 3. A decrease in optical power below the specified level will cause the SIGNAL DETECT to change from a High state to a Low state.
- 4. AC/AC for data. Load 50 Ω to GND or 100 Ω differential. For dynamic measurement a tolerance of 50 mV should be added.
- 5. Supply current excluding Rx output load.
- 6. Fibre Channel PI Standard.
- 7. Measured at the given Stressed Receiver Eyeclosure Penalty and DCD component given in Fibre Channel PI Standard (2.03/2.18 dB & 40/80 ps).

Pin Description

| Pin Na | ame | Level/ Logic | Pin# | Description |
|------------------|------------------------------------|-----------------|------------------------------------|---|
| V _{EEr} | Receiver Signal Ground | N/A | 1 | |
| V _{CCr} | Receiver Power Supply | N/A | 2 | |
| SD | Signal Detect | TTL | 3 | Normal Operation: Logic " 1" Output, represents that light is present at re- ceiver input Fault Condition: Logic " 0" Output |
| RD- | Received Data Out Not | PECL | 4 | |
| RD+ | Received Data Out | PECL | 5 | |
| V _{CCt} | | N/A | 6 | Transmitter Power Supply |
| V _{EEt} | | N/A | 7 | Transmitter Signal Ground |
| TxDis | Transmitter Disable/Enable | TTL Input | 8 | A low signal switches the laser on. A high signal switches the laser off. If not connected the Tx is disabled. |
| TD+ | Transmit Data | PECL | 9 | Transmitter Data In |
| TD- | Transmit Data Not | PECL | 10 | Transmitter Data In |
| MS | MS Package Grounding Tabs | N/A | MS1 MS2 T1 T2 T3 T4 | Mounting Studs and grounding Tabs are provided for transceiver mechanical attachment to the circuit board. They also provide an optional con- nection of the transceiver to the equipment chassis ground. The holes in the circuit board must be tied to chassis ground. |

Regulatory Compliance

| Feature | Standard | Comments |
|--|--|--|
| ESD: Electrostatic Discharge to the Electrical Pins | EIA/JESD22- A114-A (MIL-STD 883D Method 3015.7) | Class 1 (>1000 V) |
| Immunity: Against Electro- static Discharge (ESD) to the Duplex LC Receptacle | EN 61000-4-2 IEC 61000-4-2 | Discharges ranging from ± 2 kV to ± 15 kV on the receptacle cause no damage to transceiver (under recommended conditions). |

| Feature | Standard | Comments |
|--|--|---|
| Immunity: Against Radio Fre- quency Electro- magnetic Field | EN 61000-4-3 IEC 61000-4-3 | With a field strength of 3 V/m rms, noise frequency ranges from 10 MHz to 2 GHz. No ef- fect on transceiver perfor- mance between the specification limits. |
| Emission: Electromagnetic Interference (EMI) | FCC 47 CFR Part 15, Class B EN 55022 Class B CISPR 22 | Noise frequency range: 30 MHz to 18 GHz |

EYE SAFETY

This laser based multimode transceiver is a Class 1 product. It complies with IEC 60825-1 and FDA 21 CFR 1040.10 and 1040.11.

To meet laser safety requirements the transceiver shall be operated within the Absolute Maximum Ratings.

Caution

All adjustments have been made at the factory prior to shipment of the devices. No maintenance or alteration to the device is required.

Tampering with or modifying the performance of the device will result in voided product warranty.

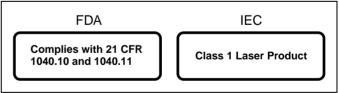
Note

Failure to adhere to the above restrictions could result in a modification that is considered an act of "manufacturing", and will require, under law, recertification of the modified product with the U.S. Food and Drug Administration (ref. 21 CFR 1040.10 (i)).

Laser Data

| Wavelength | 850 nm |
|--|---------|
| Total output power (as defined by IEC: 7 mm aperture at 1.4 cm distance) | <675 µW |
| Total output power (as defined by FDA: 7 mm aperture at 20 cm distance) | <70 µW |
| Beam divergence | 12° |

Required Labels



Laser Emission

| Indication of | | 0 | 10 9 8 7 6 |
|----------------------------|----|---|------------|
| laser aperture and beam | Тx | | |
| | Rx | | |
| | | 0 | 1 2 3 4 5 |
| | | | |

APPLICATION NOTES

EMI-Recommendation

To avoid electromagnetic radiation exceeding the required limits please read the following recommendations:

Whenever high speed Gigabit switching components are located on the PCB (also multiplexers, clock recoveries ...) any opening of the machine may generate radiation even at different locations. Thus every mechanical opening or aperture should be as small as possible.

On the board itself every data connection should be an impedance matched line (e.g. strip line, coplanar strip line). Data, Datanot should be routed symmetrically, via's should be avoided. A symmetrically matching resistor of 100 Ω should be placed at the end of each matched line. An alternative termination can be provided with a 50 Ω resistor at each (D, Dn). In DC coupled systems an artificial 50 Ω resistance can be achieved as follows: For 3.3 V: 125 Ω to V_{CC} and 82 Ω to V_{EE}, for 5 V: 82 Ω to V_{CC} and 125 Ω to V_{EE} at Data and Datanot. Please consider whether there is an internal termination inside an IC or a transceiver.

It is recommended that chassis GND and signal GND should remain separate if there are openings or apertures of the hous-

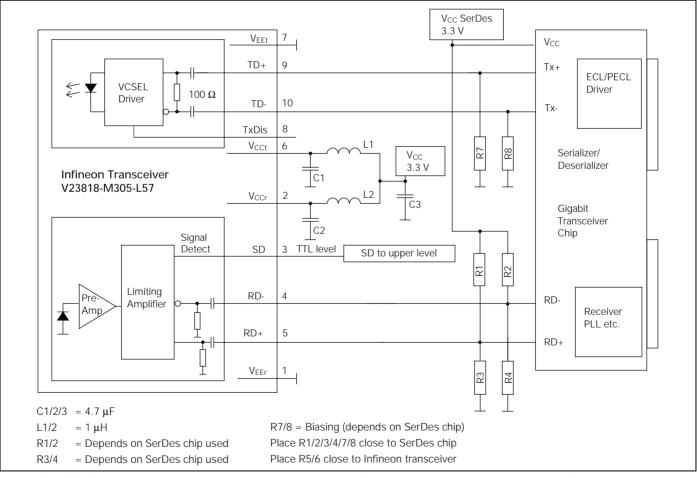
Multimode 850 nm Fibre Channel 2x5 Transceiver, AC/AC TTL

ing nearby. Sometimes signal GND is the most harmful source of radiation. Connecting chassis GND and signal GND at the plate/ bezel/ backside wall e.g. by means of a fiber optic transceiver may result in a huge amount of radiation. Even a capacitive coupling between signal GND and chassis may be harmful if it is to close to an opening or an aperture.

If a separation of signal GND and chassis GND is not possible, it is strongly recommended to provide a proper contact between signal GND and chassis GND at almost every location. This concept is suitable to avoid hotspots. Hotspots are places of highest radiation which could be generated if only a few connections between signal and chassis GND are available. Compensation currents would concentrate at these connections, causing radiation.

For the SFF transceiver a connection of the 4 housing pins to chassis GND is recommended. If no separate chassis GND is available on the users PCB the pins should be connected to signal GND. In this case take care of the notes above.

Please consider that the PCB may behave like a waveguide. With an ϵ_r of 4, the wavelength of the harmonics inside the PCB will be half of that in free space. In this case even small PCBs may have unexpected resonances.



Values of R1/2/3/4 may vary as long as proper 50 Ω termination to V_{EE} or 100 Ω differential is provided. The power supply filtering is required for good EMI performance. Use short tracks from the inductor L1/L2 to the module V_{CC}Rx/V_{CC}Tx.

The transceiver contains an automatic shutdown circuit. Reset is only possible if the power is turned off, and then on again. ($V_{CC}Tx$ switched below V_{TH}).

Application Board available on request.

Notes

Drawings

The drawing below gives you a comparison between the different pinnings 2x5, 2x6, 2x10. Dimension for diameter and distance of additional pins is similar to the existing dimensions of the other pins.

Pin Description

The numbering of the pins in the table Pin Description (page 4) is according to the 2x6 pinning.

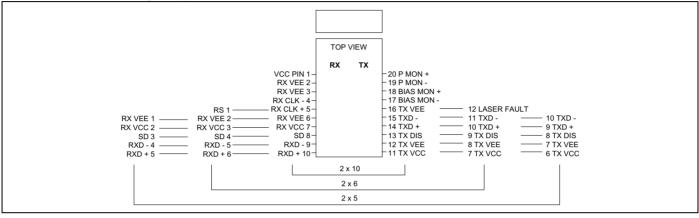
Small Form Factor Pinning Comparison

RS pin

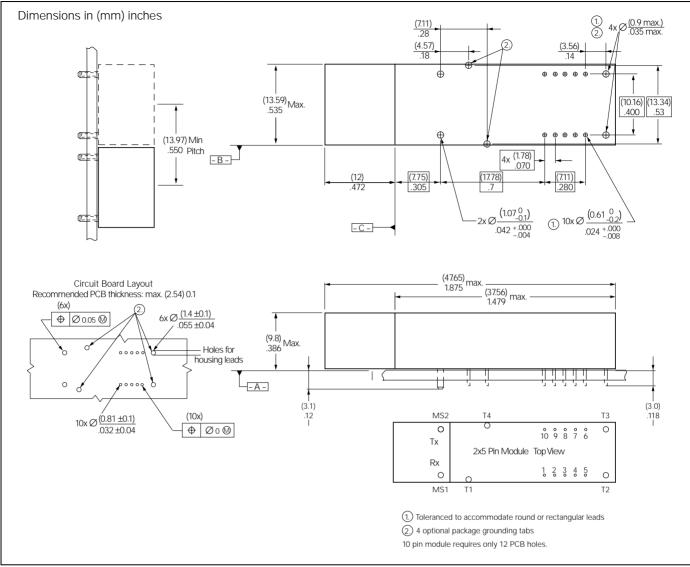
The RS Rate Select: is not connected.

LF pin

The LF pin (Laser Fault) is a TTL output of the Laser Driver Supervisor Circuit. A Logic "1" level can be measured in case of a laser fault. It will not show a fault if the laser is being disabled using the TxDis input, since this is not a fault condition.



Small Form Factor multisourcing footprint and dimensions



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